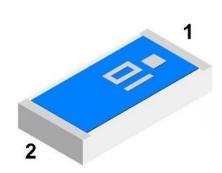
FEATURES

- 1. Surface Mounted Devices with a small dimension of 3.2 X 1.6 X 0.6 mm³ meet future miniaturization trend.
- 2. LTCC process.
- 3. High stability in Temperature / Humidity Change.
- 4. Superb performance to place on the middle of PCB edge and excellent peak/ average gain observed by field test application.

APPLICATIONS

- 1. ISM Band 2.4GHz applications.
- 2. Bluetooth...

CONSTRUCTION





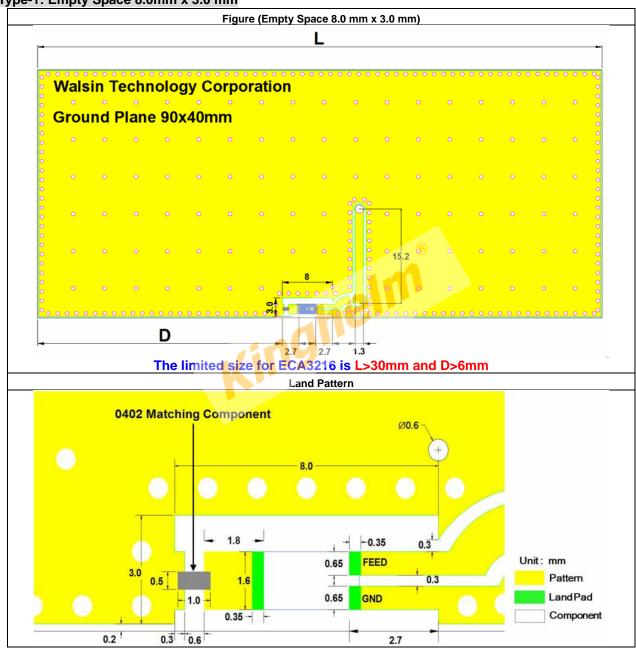
PIN	Connection
1	Feeding
2	Soldering terminal

DIMENSIONS

Figure	Symbol	Dimension (mm)
W = T = 1.6 ±0.2 mm 0.6 ±0.1 mm	L	3.10 ± 0.20
mm 2.	W	1.60 ± 0.20
3.1 ±0.2 mm A = 0.25±0.2 mm	Т	0.60 ± 0.10
	А	0.25 ± 0.20

SOLDER LAND PATTERN DESIGN

Type-1: Empty Space 8.0mm x 3.0 mm

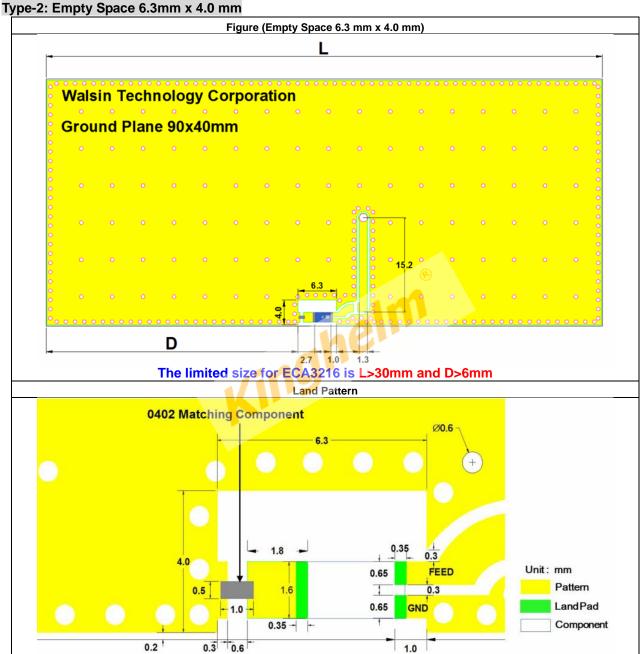


TYPE-1 TEST BOARD ELECTRONIC CHARACTERISTICS

Item	Specification
Working Frequency Range	2.4GHz~2.4835GHz (Note-1)
Gain	2 dBi (Typical)
VSWR	2.0 max.
Polarization	Linear
Azimuth Beamwidth	Omni-directional
Impedance	50Ω
Power Capacity	3 W max.
Maximum Input Power	5 Watts for 5 minutes

*Note 1. Central Frequency should be defined after customers' application approval.



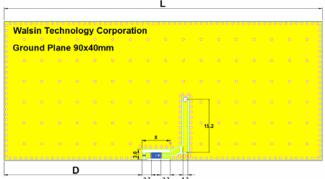


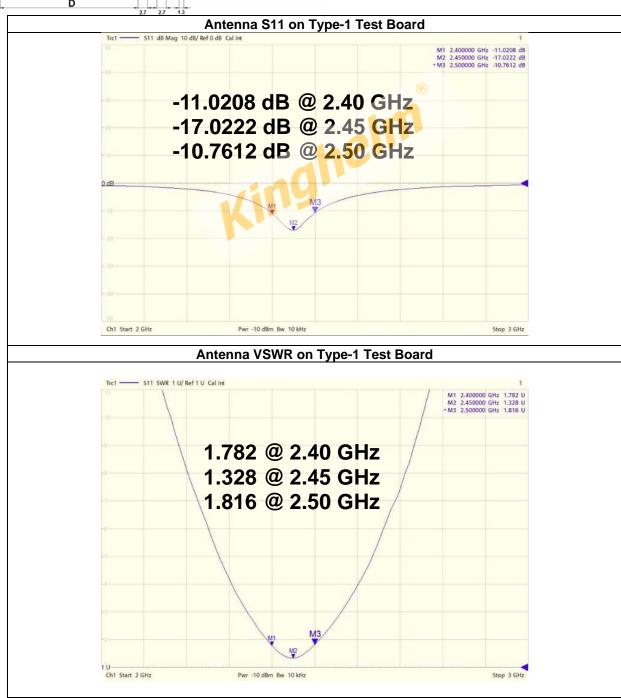
TYPE-2 TEST BOARD ELECTRONIC CHARACTERISTICS

Item	Specification
Working Frequency Range	2.4GHz~2.4835GHz (Note-1)
Gain	2 dBi (Typical)
VSWR	2.0 max.
Polarization	Linear
Azimuth Beamwidth	Omni-directional
Impedance	50Ω
Power Capacity	3 W max.
Maximum Input Power	5 Watts for 5 minutes

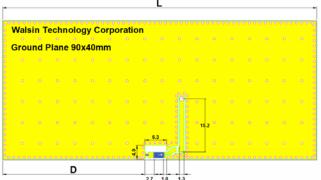
*Note 1. Central Frequency should be defined after customers' application approval.

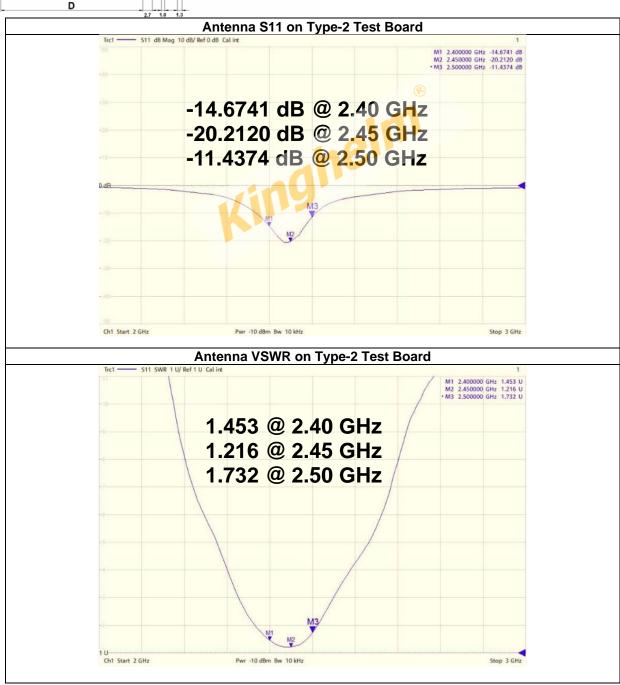
Antenna on Type-1 Test Board (Empty Space 8x3 mm &Thick ness 0.8mm)





Antenna on Type-2 Test Board (Empty Space 6.3x4 mm &Thick ness 0.8mm)

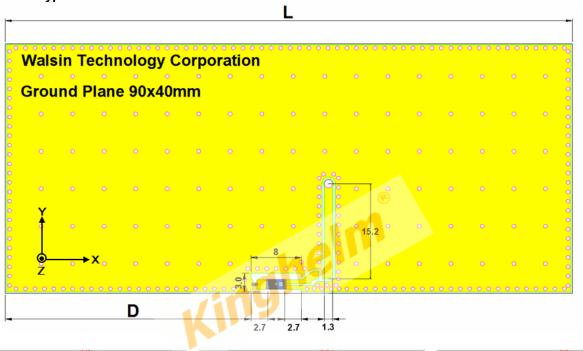


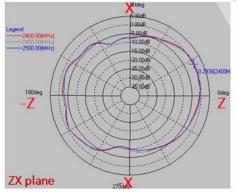


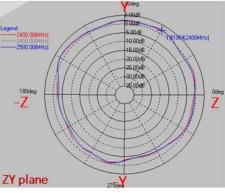
RADIATION PATTERN

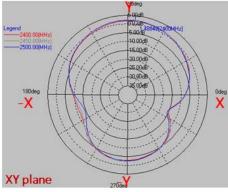
Radiation Pattern and Gain were dependent on measurement board design. The specification of RFECA3216060A1T antenna was measured based on the PCB size and installation position as shown in the below figure Test Board.

Antenna on Type-1 Test Board



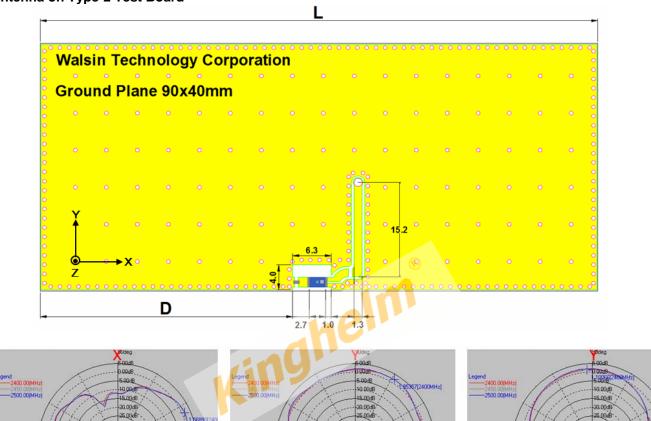


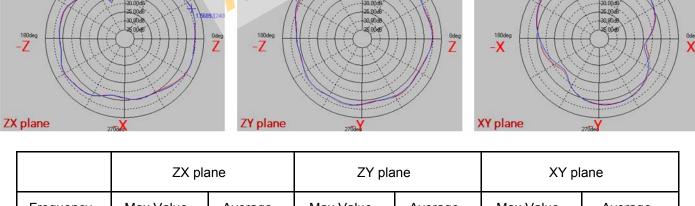




	ZX plane		ZX plane ZY plane		XY pl	ane
Frequency [MHz]	Max Value [dB]	Average [dB]	Max Value [dB]	Average [dB]	Max Value [dB]	Average [dB]
2400	0.29	-3.32	1.82	-0.51	1.49	-2.87
2450	0.55	-2.88	2.00	-0.21	1.95	-2.48
2500	-0.15	-3.44	1.82	-0.62	1.82	-2.73

Antenna on Type-2 Test Board





	ZX plane		ZY plane		XY plane	
Frequency [MHz]	Max Value [dB]	Average [dB]	Max Value [dB]	Average [dB]	Max Value [dB]	Average [dB]
2400	1.57	-2.83	1.95	-0.76	1.10	-2.93
2450	1.70	-2.62	2.00	-0.62	1.57	-2.61
2500	1.46	-2.82	1.90	-0.71	1.75	-2.68



RELIABILITY TEST

Test item	Test condition / Test method	Specification
Solderability	*Solder bath temperature : 235 ± 5°C	At least 95% of a surface of each terminal
JIS C 0050-4.6	*Immersion time : 2 ± 0.5 sec	electrode must be covered by fresh solder.
JESD22-B102D	Solder : Sn3Ag0.5Cu for lead-free	
Leaching (Resistance to dissolution of metallization) IEC 60068-2-58 Resistance to soldering heat JIS C 0050-5.4	*Solder bath temperature : 260 ± 5°C *Leaching immersion time : 30 ± 0.5 sec Solder : SN63A *Preheating temperature : 120~150°C, 1 minute. *Solder temperature : 270±5°C *Immersion time : 10±1 sec Solder : Sn3Ag0.5Cu for lead-free Measurement to be made after keeping at room temperature for 24±2 hrs	Loss of metallization on the edges of each electrode shall not exceed 25%. No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C. Loss of metallization on the edges of each electrode shall not exceed 25%.
Drop Test JIS C 0044 Customer's specification.	*Height: 75 cm *Test Surface: Rigid surface of concrete or steel. *Times: 6 surfaces for each units: 2 times for each side.	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Vibration JIS C 0040	*Frequency: 10Hz~55Hz~10Hz(1min) *Total amplitude: 1.5mm *Test times: 6hrs.(Two hrs each in three mutually perpendicular directions)	No mechanical damage. Electrical specification shall satisfy the descriptions in electrical characteristics under the operational temperature range within -40 ~ 85°C.
Adhesive Strength of Termination JIS C 0051- 7.4.3	*Pressurizing force : 5N(≦0603) ; 10N(>0603) *Test time : 10±1 sec	No remarkable damage or removal of the termination.



Bending test	The middle part of substrate shall be	No machanical damage
JIS C 0051- 7.4.1	pressurized by means of the pressurizing rod	No mechanical damage.
		Electrical specification shall satisfy the
	at a rate of about 1 mm/s per second until the	descriptions in electrical characteristics under
	deflection becomes 1mm/s and then pressure	the operational temperature range within -40
	shall be maintained for 5±1 sec.	~ 85°C.
	Measurement to be made after keeping at	
	room temperature for 24±2 hours	
Temperature cycle	1. 30±3 minutes at -40°C±3°C,	No mechanical damage.
JIS C 0025	2. 10~15 minutes at room temperature,	Electrical specification shall satisfy the
	3. 30±3 minutes at +85°C±3°C,	descriptions in electrical characteristics under
	4. 10~15 minutes at room temperature,	the operational temperature range within -40 ~ 85°C.
	Total 100 continuous cycles	
	Measurement to be made after keeping at	(S)
	room temperature for 24±2 hrs	
High temperature	*Temperature : 85°C±2°C	No mechanical damage.
JIS C 0021	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
	Measurement to be made after keeping at	descriptions in electrical characteristics under
	room temperature for 24±2 hrs	the operational temperature range within -40
	Toom temperature for 24-12 firs	~ 85°C.
Humidity	*Humidity: 90% to 95% R.H.	No mechanical damage.
(steady conditions)	*Temperature : 40±2°C	Electrical specification shall satisfy the
JIS C 0022	*Time: 1000+24/-0 hrs.	descriptions in electrical characteristics under
		the operational temperature range within -40
	Measurement to be made after keeping	~ 85°C.
	at room temperature for 24±2 hrs	
	1000hrs data	
Low temperature	*Temperature : -40°C±2°C	No mechanical damage.
JIS C 0020	*Test duration: 1000+24/-0 hours	Electrical specification shall satisfy the
		descriptions in electrical characteristics under
	Measurement to be made after keeping at	the operational temperature range within -40
	room temperature for 24±2 hrs	~ 85°C.
		00 0.
]

SOLDERING CONDITION

Typical examples of soldering processes that provide reliable joints without any damage are given in Fig 2

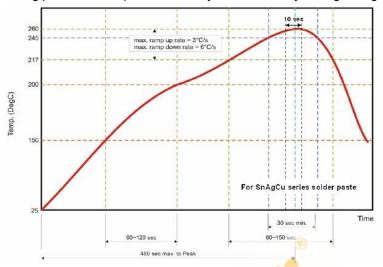


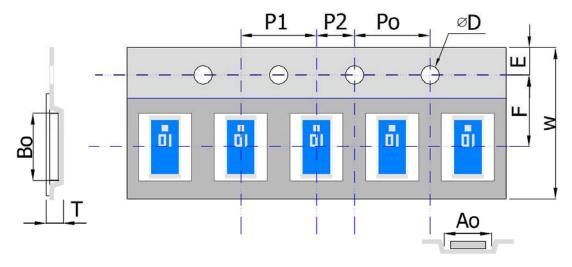
Fig 2. Infrared soldering profile

ORDERING CODE

RF	ECA	321606	0	A	1	Т
Walsin	Product	Dimension code	Unit of	Application	Specification	Packing
RF	code	Per 2 digits of	dimension	A: 2.4GHz ISM	Design Code	T : Reeled
device	ANT:	Length, Width,	0:0.1 mm	Band		
	Antenna	Thickness :	1 : 1.0 mm			
		e.g. :				
		321606 =				
		Length 32,				
		Width 16,				
		Thickness 06				

Minimum Ordering Quantity: 2000 pcs per reel.

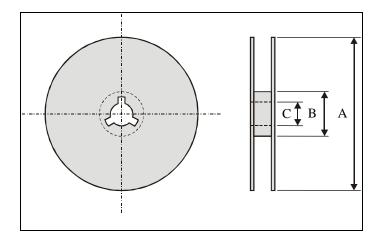
PACKAGING



Plastic Tape specifications (unit :mm)

Index	Ao	Во	ΦD	Т	W
Dimension (mm)	1.85 ± 0.10	3.45 ± 0.10	1.55 ± 0.05	0.75 ± 0.10	8.00 ± 0.30
Index	E	F	Po	P1	P2
Dimension (mm)	1.75 ± 0.10	3.50 ± 0.05	4.00 ± 0.10	4.00 ± 0.10	2.00 ± 0.10

Reel dimensions



Index	Α	В	С
Dimension (mm)	Ф178.0	Ф60.0	Ф13.0

Taping Quantity:2000 pieces per 7" reel

CAUTION OF HANDLING

Limitation of Applications

Please contact us before using our products for the applications listed below which require especially high reliability for the prevention of defects, which might directly cause damage to the third party's life, body or property.

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Medical equipment
- (5) Disaster prevention / crime prevention equipment
- (6) Traffic signal equipment
- (7) Transportation equipment (vehicles, trains, ships, etc.)
- (8) Applications of similar complexity and /or reliability requirements to the applications listed in the above.

Storage condition

- (1) Products should be used in 6 months from the day of WALSIN outgoing inspection.
- (2) Storage environment condition.
 - Products should be storage in the warehouse on the following conditions.

Temperature : +5 to +40°C

Humidity : 30 to 70% relative humidity

- Don't keep products in corrosive gases such as sulfur. Chlorine gas or acid or it may cause oxidization of electrode, resulting in poor solderability.
- Products should be storage on the palette for the prevention of the influence from humidity, dust and son on.
- Products should be storage in the warehouse without heat shock, vibration, direct sunlight and so on.
- Products should be storage under the airtight packaged condition.